



Queensland University of Technology
Brisbane Australia

This may be the author's version of a work that was submitted/accepted for publication in the following source:

Chen, Wei, Chen, Shi, Huang, Han, Qi, Dong Chen, Gao, Xing Yu, & Wee, Andrew Thye Shen

(2008)

Molecular orientation dependent interfacial dipole at the F16CuPc/CuPc organic heterojunction interface.

Applied Physics Letters, 92(6), Article number: 063308.

This file was downloaded from: <https://eprints.qut.edu.au/124325/>

© **American Institute of Physics**

This work is covered by copyright. Unless the document is being made available under a Creative Commons Licence, you must assume that re-use is limited to personal use and that permission from the copyright owner must be obtained for all other uses. If the document is available under a Creative Commons License (or other specified license) then refer to the Licence for details of permitted re-use. It is a condition of access that users recognise and abide by the legal requirements associated with these rights. If you believe that this work infringes copyright please provide details by email to qut.copyright@qut.edu.au

Notice: *Please note that this document may not be the Version of Record (i.e. published version) of the work. Author manuscript versions (as Submitted for peer review or as Accepted for publication after peer review) can be identified by an absence of publisher branding and/or typeset appearance. If there is any doubt, please refer to the published source.*

<https://doi.org/10.1063/1.2857460>

Molecular orientation dependent interfacial dipole at the $F_{16}CuPc$ / $CuPc$ organic heterojunction interface

Cite as: Appl. Phys. Lett. **92**, 063308 (2008); <https://doi.org/10.1063/1.2857460>

Submitted: 06 December 2007 . Accepted: 24 January 2008 . Published Online: 15 February 2008

Wei Chen, Shi Chen, Han Huang, Dong Chen Qi, Xing Yu. Gao, and Andrew Thye Shen Wee



View Online



Export Citation

ARTICLES YOU MAY BE INTERESTED IN

[Orientation-controlled charge transfer at \$CuPc/F_{16}CuPc\$ interfaces](#)

Journal of Applied Physics **106**, 064910 (2009); <https://doi.org/10.1063/1.3225918>

[Does the molecular orientation induce an electric dipole in Cu-phthalocyanine thin films?](#)

Journal of Applied Physics **99**, 093705 (2006); <https://doi.org/10.1063/1.2192978>

[Organic electroluminescent diodes](#)

Applied Physics Letters **51**, 913 (1987); <https://doi.org/10.1063/1.98799>



Measure Ready
M91 FastHall™ Controller

A revolutionary new instrument
for complete Hall analysis

Lake Shore
CRYOTRONICS

Molecular orientation dependent interfacial dipole at the $F_{16}CuPc/CuPc$ organic heterojunction interface

Wei Chen,^{a)} Shi Chen, Han Huang, Dong Chen Qi, Xing Yu. Gao, and Andrew Thye Shen Wee^{b)}

Department of Physics, National University of Singapore, 2 Science Drive 3, Singapore 117542, Singapore

(Received 6 December 2007; accepted 24 January 2008; published online 15 February 2008)

In situ synchrotron-based near-edge x-ray absorption fine structure measurements and photoemission spectroscopy have been used to investigate the effect of molecular orientation on the interfacial dipole and the energy level alignment at the interfaces of organic heterojunctions comprising copper-hexadecafluoro-phthalocyanine ($F_{16}CuPc$) on both standing-up and lying-down copper(II) phthalocyanine (CuPc) thin films. It is found that $F_{16}CuPc$ thin films adopt the same molecular orientation of the underlying CuPc thin films. An interfacial dipole of 0.45 eV forms at the interface of lying-down $F_{16}CuPc/CuPc$ on highly ordered pyrolytic graphite. In contrast, a much larger interfacial dipole of 1.35 eV appears at the interface of standing-up $F_{16}CuPc/CuPc$ on octane-1-thiol terminated Au(111). © 2008 American Institute of Physics.

[DOI: 10.1063/1.2857460]

Energy level alignment and the interfacial dipole formation at the organic-electrode or organic heterojunction interface play key roles in determining the performance of organic electronic devices, including organic light-emitting diodes (OLEDs), organic field-effect transistors (OFETs), and organic solar cells.^{1,2} Intensive research efforts have focused on the understanding of electronic structures near organic/inorganic or organic/organic interfaces,¹⁻⁴ and the engineering of the interface properties to improve device performance via various surface modification schemes.⁵⁻⁹ Another important factor that affects device performance is the molecular orientation near the interfaces, which is mainly governed by molecule-substrate interfacial interactions or the electronic structure of substrates.^{10,11} Many organic electronic devices such as OLEDs, ambipolar OFETs, or organic solar cells, frequently incorporate multiplicity of tailored organic layers with predefined molecular orientation. However, how the molecular orientation affects the interfacial dipole and the energy level alignment at the organic heterojunction interface is less understood.

In this letter, *in situ* synchrotron-based near-edge x-ray absorption fine structure (NEXAFS) measurements and photoemission spectroscopy (PES) are used to evaluate the effect of molecular orientation on interfacial dipole formation and the energy level alignment at organic heterojunction interfaces comprising copper-hexadecafluoro-phthalocyanine ($F_{16}CuPc$) on copper(II) phthalocyanine (CuPc) with well-defined molecular orientations. Figure 1(a) shows the molecular structures of both molecules. This particular organic heterojunction has promising applications in ambipolar OFETs.¹²⁻¹⁴ We report the formation of orientation dependent interfacial dipoles at the $F_{16}CuPc/CuPc$ interface.

In situ PES and NEXAFS measurements were carried out at the SINS beamline of the Singapore Synchrotron Light Source.^{8,9,15} A monolayer of octane-1-thiol self-assembled monolayer (C8-SAM) was formed by spontaneous adsorp-

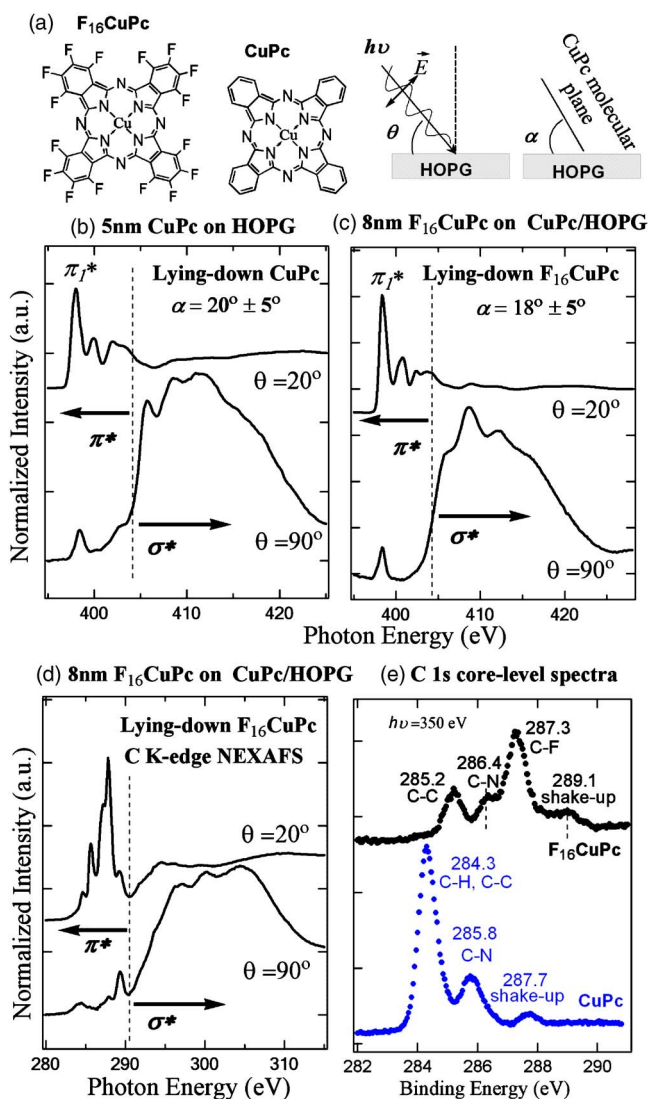


FIG. 1. (Color online) (a) Molecular structure of $F_{16}CuPc$ and CuPc. Angle-dependent N K -edge NEXAFS spectra for (b) 5 nm CuPc on HOPG, (c) 8 nm $F_{16}CuPc$ on CuPc on HOPG, and (d) corresponding C K -edge NEXAFS spectra of 8 nm $F_{16}CuPc$ on CuPc on HOPG. (e) C $1s$ core-level spectra of 5 nm CuPc on HOPG and 8 nm $F_{16}CuPc$ on CuPc on HOPG.

^{a)} Authors to whom correspondence should be addressed. Electronic mail: phycw@nus.edu.sg.

^{b)} Authors to whom correspondence should be addressed. Electronic mail: phyweets@nus.edu.sg.

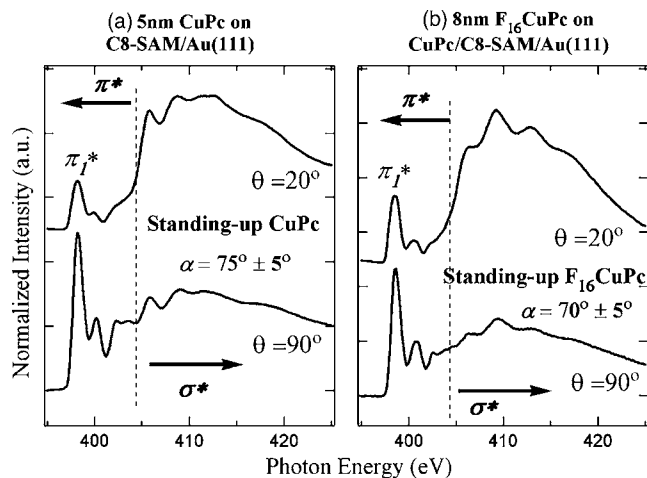


FIG. 2. (a) Angle-dependent N *K*-edge NEXAFS spectra for the 5 nm CuPc on C8-SAM/Au(111), (b) are the N *K*-edge NEXAFS spectra after deposition of 8 nm of F₁₆CuPc on CuPc.

tion on Au(111)/mica substrates (SPI, U.S.A.) in 3 ml of 1 mM solution in a N₂ environment for 48 h, using absolute ethanol as the solvent.¹⁶ F₁₆CuPc and CuPc (Sigma-Aldrich) were *in situ* deposited from two K cells in the main analysis chamber of the SINS beamline (for F₁₆CuPc) and the preparation chamber (for CuPc) onto substrates of highly ordered pyrolytic graphite (HOPG) and C8-SAM/Au(111) held at room temperature. Prior to the deposition, F₁₆CuPc was pu-

rified twice via vacuum sublimation (Creaphys GmbH). The deposition rates for both molecules (0.1 nm/min for F₁₆CuPc and 0.2 nm/min for CuPc) were calibrated by monitoring the attenuation of the Au 4*f*_{7/2} peak intensity before and after the deposition on a sputter-cleaned poly-Au sample.¹⁷

For F₁₆CuPc and CuPc monolayers on HOPG, both molecules adopt the lying-down configuration with their extended π -plane parallel to substrate surface, arising from the directional interfacial π - π interactions between π electrons in HOPG and those in F₁₆CuPc and CuPc.^{18,19} Figure 1(b) shows the nitrogen *K*-edge NEXAFS spectra of 5 nm CuPc on HOPG as a function of the *p*-polarized synchrotron light incidence angle θ . The first three sharp absorption peaks (397–404 eV) in Fig. 1(b) are assigned to the excitations from N 1*s* core level to individual π^* states, and the broad absorption peaks at higher photon energy (404–415 eV) are transitions to the σ^* states.^{8,9} The intensity *I* of the π_1^* resonance is related to the tilt angle α of the CuPc molecular plane with respect to the substrate plane and the synchrotron light incidence angle θ by²⁰

$$I(\theta) \propto 1 + \frac{1}{2}(3 \cos^2 \theta - 1)(3 \cos^2 \alpha - 1).$$

Using the intensity ratio $R(\pi_1^*) = I(90^\circ)/I(20^\circ)$, we estimate the average tilt angle α for 5 nm CuPc on HOPG to be $20^\circ \pm 5^\circ$. Figure 1(c) shows the angle-dependent N *K*-edge NEXAFS spectra of 8 nm F₁₆CuPc on 5 nm CuPc (lying

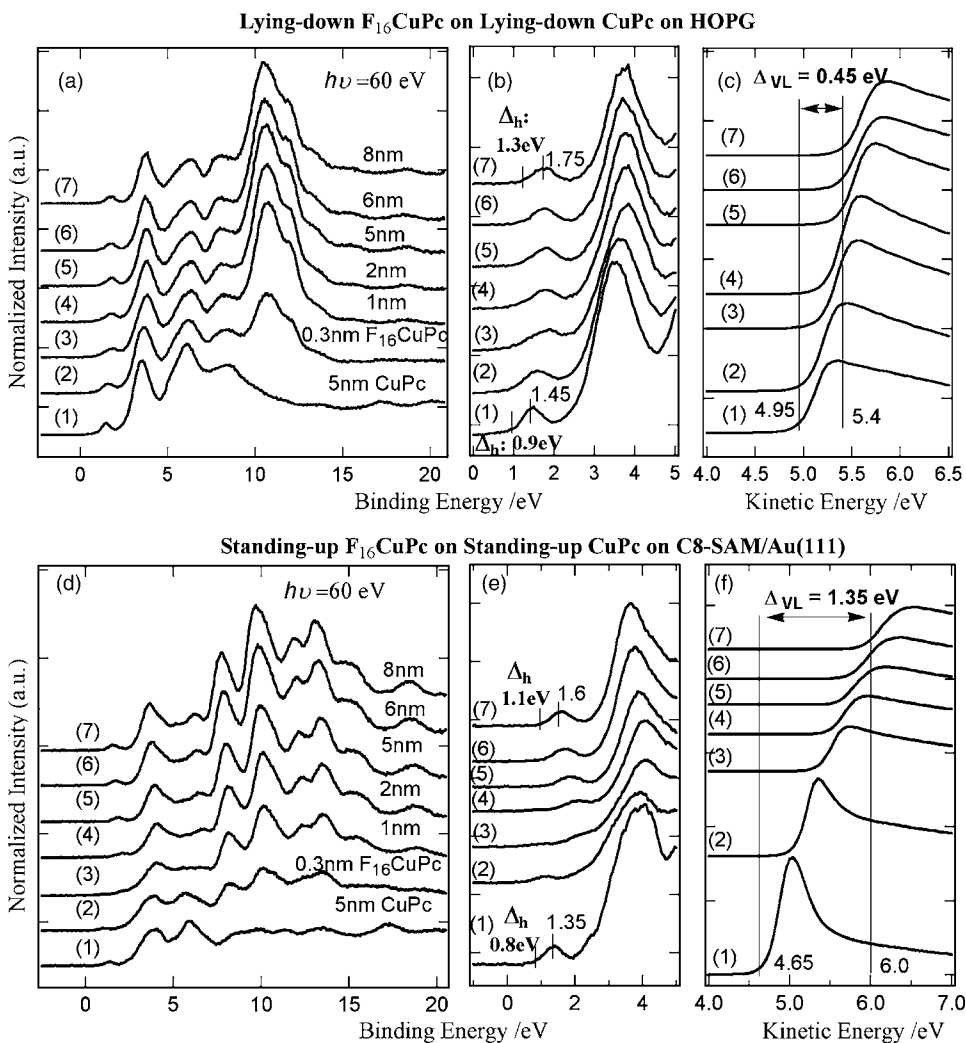


FIG. 3. Synchrotron PES spectra during the deposition of F₁₆CuPc on [(a)–(c)] 5 nm CuPc (lying down) on HOPG and [(d)–(f)] 5 nm CuPc (standing up) on C8-SAM/Au(111): [(a) and (d)] valence band spectra at the low-binding energy part, and [(b) and (e)] corresponding near the E_F region spectra from panels a and d, and [(c) and (f)] PES spectra at the low-kinetic energy part (secondary electron cutoff). All spectra are measured with photon energy of 60 eV. All binding energies are relative to the Fermi level position of the electron analyzer.

down) on HOPG. The average tilt angle α of F₁₆CuPc was estimated to be $18^\circ \pm 5^\circ$, indicating that F₁₆CuPc molecules lie flat on the lying down CuPc thin film. The C *K*-edge NEXAFS spectra of 8 nm F₁₆CuPc on 5 nm CuPc on HOPG [Fig. 1(d)] shows similar angular dependence, confirming the flat-lying geometry of F₁₆CuPc on the lying-down CuPc thin film. Figure 1(e) shows the C 1*s* core-level spectra of 5 nm CuPc on HOPG and 8 nm F₁₆CuPc on CuPc, revealing the different carbon species (C–H, C–C, C–N, or C–F) in both molecules.

On Au(111), CuPc adopts a lying down configuration due to the strong interfacial interactions between the metal *d* bands and conjugated π system (*d*– π interaction).⁸ However, by terminating Au(111) with SAMs, the *d*– π interface interaction is minimized, causing CuPc to stand up on the substrate.^{8,9} Figure 2(a) shows the angle-dependent N *K*-edge NEXAFS spectra of 5 nm CuPc on C8-SAM/Au(111), clearly revealing the standing-up configuration of CuPc thin film on the passivated Au(111) with average tilt angle α of $75^\circ \pm 5^\circ$. After depositing 8 nm F₁₆CuPc on the standing-up CuPc thin film on C8SAM/Au(111), F₁₆CuPc maintains a similar standing-up orientation ($\alpha = 70^\circ \pm 5^\circ$) with that of the underlying CuPc, as indicated by the angle-dependent NEXAFS spectra in Fig. 2(b).

The orientation dependent interfacial dipole formation and energy level alignment at the F₁₆CuPc/CuPc interfaces have been investigated by PES. Figure 3 shows the evolution of PES valence band spectra at the low-binding energy region [Figs. 3(a), 3(b), 3(d), and 3(e)] and spectra at the low-kinetic energy region [Figs. 3(c) and 3(f)] after the sequential deposition of F₁₆CuPc on both the lying-down and standing-up CuPc thin films. The hole injection barriers (Δ_h) can be measured from the energy difference between the substrate Fermi level and the highest occupied molecular orbital leading edge (linear extrapolation of the low-binding energy onset),^{1–3} and are summarized in Figs. 3(b) and 3(e) for different films.

For 8 nm lying-down F₁₆CuPc on the lying-down CuPc, a work function change (vacuum level shift) by 0.45 ± 0.05 eV is observed, as shown in Fig. 3(c). This work function change most likely originates from the interfacial charge transfer involving electron transfer from the donorlike CuPc layer to the acceptorlike F₁₆CuPc top layer, leading to an electron accumulation layer in F₁₆CuPc and electron depletion layer in CuPc.^{3,14} In contrast, a much larger work function change by 1.35 ± 0.05 eV forms at the interface of 8 nm standing-up F₁₆CuPc on the standing-up CuPc thin film, as shown in Fig. 3(f). The work function changes ($\Delta\phi$) at the F₁₆CuPc-CuPc interfaces can be understood via the equation $\Delta\phi = n_{\text{pair}}\phi_{\text{pair}}$, where n_{pair} is the area density of the F₁₆CuPc-CuPc charge transfer pairs at the interfaces and ϕ_{pair} is the charge transfer induced by a single F₁₆CuPc-CuPc pair. From a simple model, n_{pair} for σ -F₁₆CuPc on σ -CuPc is roughly twice of that for λ -F₁₆CuPc on λ -CuPc, where σ denotes the standing-up configuration and λ represents the lying-down configuration. Such orientation dependence in n_{pair} gives rise to the observation that $\Delta\phi$ at the interface of σ -F₁₆CuPc on σ -CuPc is much larger than that at the interface of λ -F₁₆CuPc on λ -CuPc. The charge transfer (ϕ_{pair}) induced by a single F₁₆CuPc-CuPc pair is largely governed by the degree of intermolecular interaction or the molecular orbital coupling between F₁₆CuPc and CuPc. As compared to

the π – π interaction at the interface of λ -F₁₆CuPc on λ -CuPc, the relatively stronger C–F···H–C interaction dominates the interface of σ -F₁₆CuPc on σ -CuPc,²¹ leading to the larger charge transfer (ϕ_{pair}) of a single F₁₆CuPc-CuPc pair, thereby resulting in the orientation dependent work function changes ($\Delta\phi$) observed at the F₁₆CuPc-CuPc interfaces.

In conclusion, the molecular orientation of F₁₆CuPc on both standing-up and lying-down CuPc thin films has been investigated by *in situ* NEXAFS. It is found that F₁₆CuPc adopts the same molecular orientation as the underlying CuPc film. *In situ* PES revealed that orientation dependent interfacial dipoles form at the F₁₆CuPc/CuPc interfaces: a small work function change or weak interfacial dipole of 0.45 eV at the interface of the lying-down F₁₆CuPc/CuPc, and a much larger interfacial dipole of 1.35 eV at the interface of the standing-up F₁₆CuPc/CuPc. This detailed understanding of molecular orientation dependent interfacial dipole formation and energy level alignment at the organic heterojunction interfaces has promising implications in improving the performance of organic electronic devices, in particular, the F₁₆CuPc/CuPc based ambipolar OFETs.

The authors acknowledge the support from the A*STAR under Grant No. R-144-000-163-305 and ARF under Grant No. R-144-000-196-112.

¹H. Ishii, K. Sugiyama, E. Ito, and K. Seki, *Adv. Mater.* (Weinheim, Ger.) **11**, 605 (1999).

²A. Kahn, N. Koch, and W. Y. Gao, *J. Polym. Sci., Part B: Polym. Phys.* **41**, 2529 (2003); C. Cahen and A. Kahn, *Adv. Mater.* (Weinheim, Ger.) **15**, 271 (2003); N. Koch, *ChemPhysChem* **8**, 1438 (2007); W. Osikowicz, M. P. de Jong, and W. R. Salaneck, *Adv. Mater.* (Weinheim, Ger.) **19**, 4213 (2007).

³J. X. Tang, C. S. Lee, and S. T. Lee, *J. Appl. Phys.* **101**, 064504 (2007).

⁴C. Tengstedt, W. Osikowicz, W. R. Salaneck, I. D. Parker, C. H. Hsu, and M. Fahlman, *Appl. Phys. Lett.* **88**, 053502 (2006).

⁵N. Koch, S. Duhm, J. P. Rabe, A. Vollmer, and R. L. Johnson, *Phys. Rev. Lett.* **95**, 237601 (2005).

⁶B. de Boer, A. Hadipour, M. M. Mandoc, T. van Woudenberg, and P. W. M. Bolm, *Adv. Mater.* (Weinheim, Ger.) **17**, 621 (2005).

⁷S. Khodabakhsh, B. M. Sanderson, J. Nelson, and T. S. Jones, *Adv. Funct. Mater.* **16**, 95 (2006).

⁸W. Chen, C. Huang, X. Y. Gao, L. Wang, C. G. Zhen, D. Qi, S. Chen, H. L. Zhang, K. P. Loh, Z. K. Chen, and A. T. S. Wee, *J. Phys. Chem. B* **110**, 26075 (2006).

⁹W. Chen, X. Y. Gao, D. C. Qi, S. Chen, Z. K. Chen, and A. T. S. Wee, *Adv. Funct. Mater.* **17**, 1339 (2007).

¹⁰S. Kowarik, A. Gerlach, S. Sellner, F. Schreiber, L. Cavalcanti, and O. Kononov, *Phys. Rev. Lett.* **96**, 125504 (2006).

¹¹G. E. Thayer, J. T. Sadowski, F. M. zu Heringdorf, T. Sakurai, and R. M. Tromp, *Phys. Rev. Lett.* **95**, 256106 (2005).

¹²J. Wang, H. B. Wang, X. J. Yan, H. C. Huang, and D. H. Yan, *Appl. Phys. Lett.* **87**, 093507 (2005).

¹³J. Wang, H. B. Wang, X. J. Yan, H. C. Huang, D. Jin, J. W. Shi, Y. H. Tang, and D. H. Yan, *Adv. Funct. Mater.* **16**, 824 (2006).

¹⁴K. M. Lau, J. X. Tang, H. Y. Sun, C. S. Lee, S. T. Lee, and D. H. Yan, *Appl. Phys. Lett.* **88**, 173513 (2006).

¹⁵W. Chen, S. Chen, D. C. Qi, X. Y. Gao, and A. T. S. Wee, *J. Am. Chem. Soc.* **129**, 10418 (2007).

¹⁶W. Chen, L. Wang, C. Huang, T. T. Lin, X. Y. Gao, K. P. Loh, Z. K. Chen, and A. T. S. Wee, *J. Am. Chem. Soc.* **128**, 935 (2006).

¹⁷M. P. Seah and W. A. Dench, *Surf. Interface Anal.* **1**, 2 (1979).

¹⁸W. Chen, H. Huang, S. Chen, L. Chen, H. L. Zhang, X. Y. Gao, and A. T. S. Wee, *Appl. Phys. Lett.* **91**, 114102 (2007).

¹⁹S. R. Forrest, *Chem. Rev.* (Washington, D.C.) **97**, 1793 (1997), and references therein.

²⁰J. Stöhr, *NEXAFS Spectroscopy* (Springer, Berlin, 1992).

²¹E. Barrena, D. G. de Oteyza, H. Dosch, and Y. Wakayama, *ChemPhysChem* **8**, 1915 (2007).